SIC MOSFET RELAY A AA52

TOWARD RELAYS



# 1700V Sic mosfet relay

MGT **A** Manufacturer Group of Technology

SILICON CARBIDE SiC MOSFET RELAY ▲ DIP and SMD type High voltage with low on-resistance Fast reverse recovery time High avalanche ruggedness Moisture Sensitivity Level ▲ MSL 1 UL 1577 approved ▲ File no E344988

# SPECIFICATION

Item		Characteristics
Contact Form		1 Form A 🔺 Normally open switch
Load Voltage	VL	1700V
Operation LED Current	I <sub>F ON</sub>	5.0mA
Load Current	l,	350mA
On-Resistance	R <sub>on</sub>	2.2Ω
Output Capacitance	Соит	135pF
Low Off-State Leakage Current	I <sub>LEAK</sub>	10μA at 1700V <sub>DC</sub>

RoHS

REACH

HALOGEN

FREE

#### **APPLICATIONS**



#### DIMENSIONS

Package		Dimensions	PCB Board Pattern
DIP6-5	8.8 ±0.3 1.2 ±0.2 1.2 ±0		5-Ø0.8 5-Ø0.8
SMD6-5	8.8 ±0.3 1.2 ±0.2 0.5 ± ±0.1 0.5 ± ±0.2 0.5 ±0	15° max.	TOP VIEW

AA52 A Rev.001 A Date: 01/10/2021 A Page: 1

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TOWARD RELAYS

#### PIN DESCRIPTION AND PART NUMBER

Circuit Diagram	Pin Description	Part No.	Package	Packing
	1: Anode (+) • LED 2: Cathode (-) • LED 3: NC 4: Drain • MOSFET 1 6: Drain • MOSFET 2	AA52 AA52F AA52F-R1	DIP6-5 SMD6-5 SMD6-5	Tube (50pcs) Tube (50pcs) Reel (1000pcs)

### ABSOLUTE MAXIMUM RATINGS A AMBIENT TEMPERATURE T<sub>A</sub> = 25°C

	Item	Condition	Symbol	Value	Unit
	Continuous LED Current		I <sub>F</sub>	50	mA
la se st	Peak LED Current	100 Hz, Duty 1%	I <sub>FP</sub>	500	mA
Input	LED Reverse Voltage		V <sub>R</sub>	5	V
	Input Power Dissipation		P <sub>IN</sub>	75	mW
	Load Voltage		VL	1700	V (AC peak or DC)
<b>O</b> tt	Load Current		IL.	350	mA
Output	Peak Load Current	1 ms, 1 shot	I <sub>PEAK</sub>	1000	mA
	Output Power Dissipation	VR         5           ion $P_{IN}$ 75           VL         1700         V           Imms, 1 shot         IL         350           ation         POUT         450           on         PT         500           ge (Suffix-H)         Imms, 1 shot         PT	mW		
	Total Power Dissipation		P <sub>T</sub>	500	mW
	I/O Breakdown Voltage		V <sub>I/O</sub>	3750	Vrms
Relay	I/O Breakdown Voltage (Suffix-H)		V <sub>I/O</sub>	5000	Vrms
	Operating Temperature Range		T <sub>OPR</sub>	-40 to +85	°C
	Storage Temperature Range		T <sub>STG</sub>	-40 to +100	°C

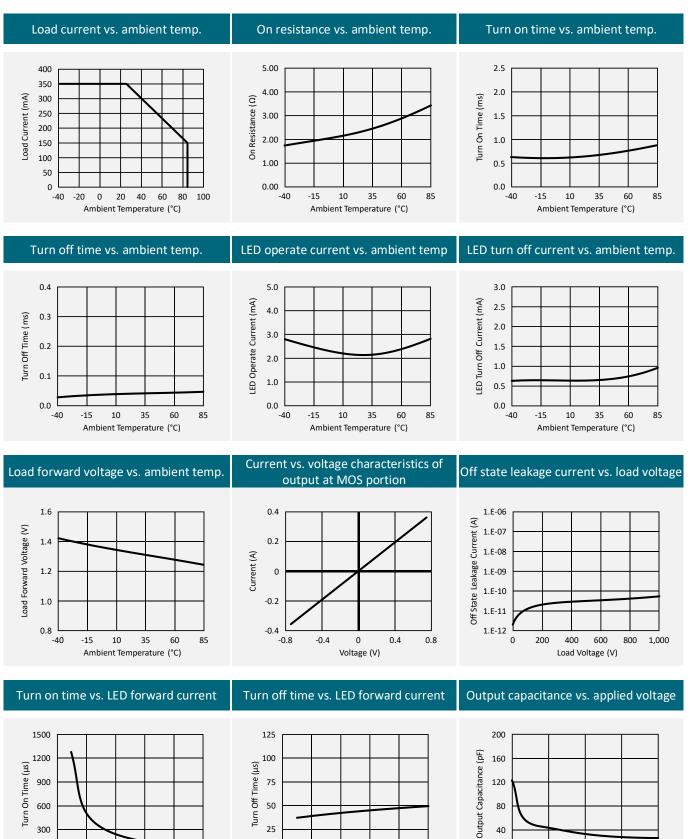
# **ELECTRICAL CHARACTERISTICS AMBIENT TEMPERATURE** T<sub>A</sub> = 25°C

	Item	Condition	Symbol	Min.	Тур.	Max.	Unit
	LED Forward Voltage	I <sub>F</sub> = 10mA	VF	1	1.33	1.5	V
Input	Operation LED Current		I <sub>F ON</sub>		2	5	mA
	Recovery LED Voltage		V <sub>F OFF</sub>	0.5	1.2		V
	On-Resistance Drain to Drain (tested within 1 sec.)	I <sub>F</sub> =10mA, I <sub>L</sub> =Rating	R <sub>ON</sub>		2.2	3.5	Ω
Output	Off-State Leakage Current	V <sub>L</sub> =1700V	I <sub>LEAK</sub>			10	μA
	Output Capacitance	$I_{F} = 10mA \qquad V_{F} \qquad 1 \qquad 1.33 \qquad 1.5 \\ I_{F ON} \qquad 2 \qquad 5 \\ V_{F OFF} \qquad 0.5 \qquad 1.2 \\ I_{F} = 10mA, I_{L} = Rating \qquad R_{ON} \qquad 2.2 \qquad 3.5 \\ I_{F} = 10mA, I_{L} = Rating \qquad I_{F} = 10mA, I_{L} = 10mA, I_$	pF				
Trans-	Turn-On Time	$I_F$ =10mA, $I_L$ =Rating	T <sub>ON</sub>		0.7	3	ms
mission	Turn-Off Time	$I_F$ =10mA, $I_L$ =Rating	T <sub>OFF</sub>		0.05	1	ms
Coupled	I/O Insulation Resistance		R <sub>I/O</sub>	10 <sup>10</sup>			Ω
Coupled	I/O Capacitance	f=1MHz	C <sub>I/O</sub>		1.3		рF



TOWARD RELAYS

#### **REFERENCE DATA**



AA52 A Rev.001 A Date: 01/10/2021 A Page: 3

LED Forward Current (mA)

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LED Forward Current (mA)

Applied Voltage (V)

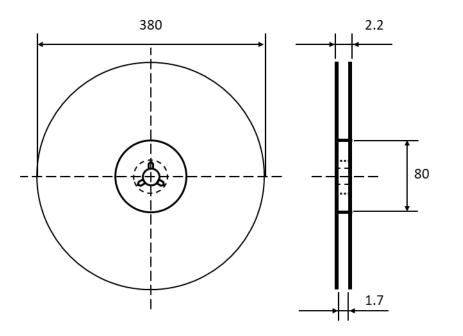
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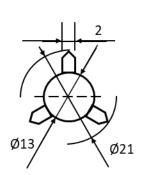


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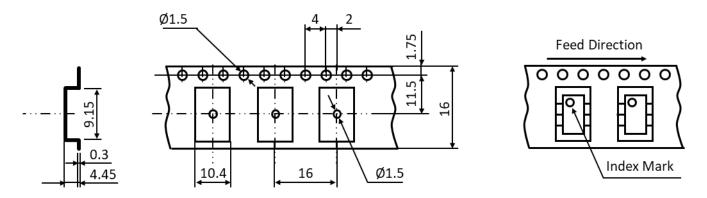


#### **REEL DIMENSIONS** All dimensions in mm





#### **TAPE DIMENSIONS** All dimensions in mm



Tape and Reel Packing	 PCS/Reel	
SMD 6-5	1000	

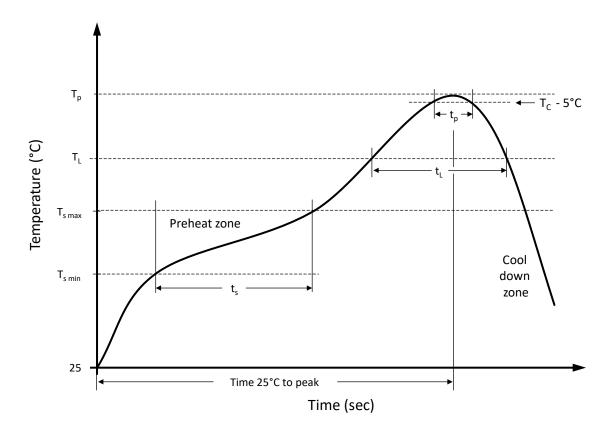
Tube Packing	PCS/Tube	Tubes/Box	Units/Box
SMD 6-5	50	30	1500
DIP 6-5	50	30	1500

# STORAGE AND HANDLING CONDITIONS

ESD level	Floor life	Conditions	MSL
HBM class 2	Unlimited	T <sub>A</sub> < 30°C, RH < 85%	1



#### **RECOMMENDED REFLOW SOLDERING PROFILE A SMD PACKAGE**



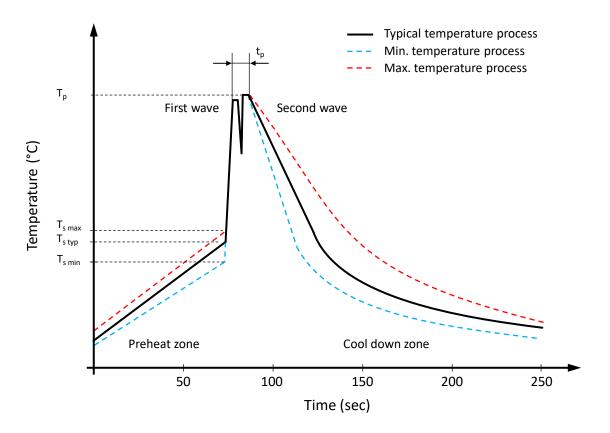
#### Recommended reflow soldering conditions ▲ Refer to JEDEC J-STD-020E

Profile Features		Sn-Pb Eutetic Assembly	Pb-Free Assembly
Preheat temperature min. T <sub>s min</sub>		100 °C	150 °C
Preheat temperature max.	$T_{smax}$	150 °C	200 °C
Preheat time t <sub>s</sub> from T <sub>s min</sub> to T <sub>s max</sub> t <sub>s</sub>		120 seconds	120 seconds
Ramp-up rate ( $T_L$ to $T_p$ )		max. 3 °C/second	max. 3 °C/second
Liquidous temperature	ΤL	183 °C	217 °C
Time $t_L$ maintained above $T_L$	tL	150 seconds max.	60 seconds max.
Peak package body temperature	Tp	235°C	260°C
Timeframe of within 5°C below and up to max actual peak body temperature	t <sub>p</sub>	20 seconds max.	30 seconds max.
Ramp-down rate ( $T_L$ to $T_p$ )		max. 6 °C/second	max. 6 °C/second
Time 25°C to peak temperature		max. 6 minutes	max. 8 minutes

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#### **RECOMMENDED WAVE SOLDERING PROFILE A THT PACKAGE**



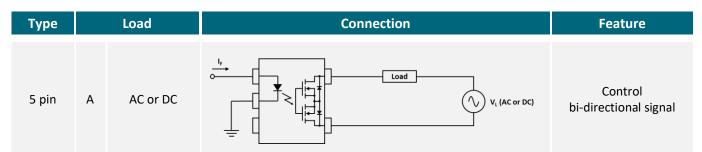
#### Classification wave soldering profile ▲ Refer to EN 61760-1: 2006

Profile Features		Value 🛦 Sn-Pb Assembly	Value A Pb-free Assembly
Preheat temperature min.	$T_{smin}$	100 °C	100 °C
Preheat temperature typical	T <sub>s typ</sub>	120 °C	120 °C
Preheat temperature max.	$T_{s  max}$	130 °C	130 °C
Preheat time $t_s$ from $T_{s min}$ to $T_{s max}$	ts	70 seconds	70 seconds
Peak temperature	Tp	235 °C to 260 °C	245 °C to 260 °C
Time of actual peak temperature	t <sub>p</sub>	Max. 10 seconds Max. 5 second each wave	Max. 10 seconds Max. 5 second each wave
Ramp-down date min.		~ 2 °C/second	~ 2 °C/second
Ramp-down rate typical		~ 3.5 °C/second	~ 3.5 °C/second
Ramp-down rate max.		~ 5 °C/second	~ 5 °C/second
Time 25°C to 25°C		4 minutes	4 minutes



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# LOAD CONNECTING METHOD

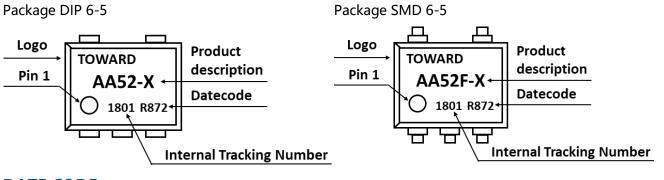


# **PRODUCT CODE**

Example: AA52 series ▲ 1700V ▲ SMD6-5 ▲ Tape & Reel

	<b>AA</b>	5	2	-		F		R1			
Pa	Package		Series Special Suffix		Series		Special Suffix		pe	Рас	king
AA AM	6-5 8-6	50 51 52 53 54 58	650V 1200V 1700V 3300V 6600V 1800V	Blank A H	Standard Low Leakage Current High Insulation	Blank F S	DIP SMD SOP	Blank R1	Tube Reel		

# **PRODUCT MARKING**



# DATE CODE

Example:	R872						
	R	8	8		7		2
Material Ch	aracteristics	Ye	ar	Мо	onth	Week of t	he Month
R	RoHS compliant	8 9 A B	2018 2019 2020 2021	1 2 3 4	Jan Feb Mar Apr	1 2	1 <sup>st</sup> 2 <sup>nd</sup>
н	Halogen free	C  G	2022  2026	5  12	May  Dec	3 4	3 <sup>rd</sup> 4 <sup>th</sup>

AA52 A Rev.001 Date: 01/10/2021 Page: 7

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# **RELIABILITY TESTS A STANDARD**

#### Standard: JESD22-A

No.	Test	Test	Test	Test
1	Moisture Sensitivity Level Test	Specification Bake condition: Temperature: 125°C; Duration 24 hours Soak condition: Temperature: 30°C; Humidity: 60% RH Duration 192 hours Reflow condition: Peak temperature: 260°C Duration: 3 cycles	Standard JESD22-A113H	Limits No abnormal phenome- non was found. Functional test passed.
2	High Temperature Storage Test	Temperature: 150°C Duration: 500 hours	JESD22-A103E	No abnormal phenome- non was found. Functional test passed.
3	Temperature Cycling Test	Temperature range: -55°C to +125°C -55°C for 30 minutes +125°C for 30 minutes Duration: 100 cycles with 1 cycle = 70 minutes	JESD22-A104E	No abnormal phenome- non was found. Functional test passed.
4	Low Temperature Storage Test	Temperature: -40°C Duration: 500 hours	JESD22-A119E	No abnormal phenome- non was found. Functional test passed.
5	Temperature & Humidity Storage Test	Temperature: 85°C Humidity: 85% RH Duration: 500 hours	JESD22-A101D	No abnormal phenome- non was found. Functional test passed.
6	Highly Accelerated Temperature and Humidity Stress Test	Temperature: 130°C Humidity: 85% RH Duration: 96 hours	JESD22-A-118B	No abnormal phenome- non was found. Functional test passed.



#### **REVISION TABLE**

Revision	Date	Status	Notes
001	01/10/2021	Initial release	Initial publication

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